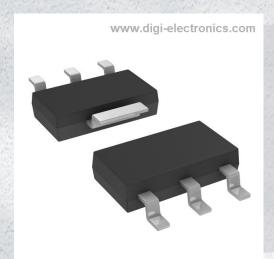


MMFT960T1G Datasheet



https://www.DiGi-Electronics.com

DiGi Electronics Part Number

MMFT960T1G-DG

Manufacturer

onsemi

Manufacturer Product Number

MMFT960T1G

Description

MOSFET N-CH 60V 300MA SOT223

Detailed Description

N-Channel 60 V 300mA (Tc) 800mW (Ta) Surface Mo

unt SOT-223 (TO-261)



Tel: +00 852-30501935

RFQ Email: Info@DiGi-Electronics.com

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Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
MMFT960T1G	onsemi
Series:	Product Status:
	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
60 V	300mA (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ ld, Vgs:
10V	1.70hm @ 1A, 10V
Vgs(th) (Max) @ Id:	Gate Charge (Qg) (Max) @ Vgs:
3.5V @ 1mA	3.2 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±30V	65 pF @ 25 V
FET Feature:	Power Dissipation (Max):
	800mW (Ta)
Operating Temperature:	Mounting Type:
-65°C ~ 150°C (TJ)	Surface Mount
Supplier Device Package:	Package / Case:
SOT-223 (TO-261)	TO-261-4, TO-261AA
Base Product Number:	
MMFT96	

Environmental & Export classification

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAROO	9541 21 0005

MMFT960T1

Preferred Device

Power MOSFET 300 mA, 60 Volts

N-Channel SOT-223

This Power MOSFET is designed for high speed, low loss power switching applications such as switching regulators, dc-dc converters, solenoid and relay drivers. The device is housed in the SOT-223 package which is designed for medium power surface mount applications.

Features

- Silicon Gate for Fast Switching Speeds
- Low Drive Requirement
- The SOT-223 Package can be Soldered Using Wave or Reflow
- The Formed Leads Absorb Thermal Stress During Soldering Eliminating the Possibility of Damage to the Die
- Pb-Free Package is Available

MAXIMUM RATINGS (T_C = 25°C unless otherwise noted)

Rating	Symbol	Value	Unit
Drain-to-Source Voltage	V _{DS}	60	V
Gate-to-Source Voltage - Non-Repetitive	V _{GS}	±30	V
Drain Current	I _D	300	mAdc
Total Power Dissipation @ T _A = 25°C (Note 1) Derate above 25°C	P _D	0.8 6.4	W mW/°C
Operating and Storage Temperature Range	T _J , T _{stg}	-65 to 150	°C

THERMAL CHARACTERISTICS

Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	156	°C/W
Maximum Temperature for Soldering Purposes	TL	260	°C
Time in Solder Bath		10	S

Maximum ratings are those values beyond which device damage can occur. Maximum ratings applied to the device are individual stress limit values (not normal operating conditions) and are not valid simultaneously. If these limits are exceeded, device functional operation is not implied, damage may occur and reliability may be affected.

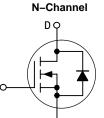
 Device mounted on a FR-4 glass epoxy printed circuit board using minimum recommended footprint.



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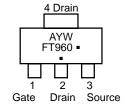
300 mA, 60 VOLTS $R_{DS(on)} = 1.7 \Omega$





TO-261AA CASE 318E STYLE 3

MARKING DIAGRAM AND PIN ASSIGNMENT



A = Assembly Location

Y = Year W = Work Week ■ = Pb-Free Package FT960 = Device Code

(Note: Microdot may be in either location)

ORDERING INFORMATION

Device	Package	Shipping [†]
MMFT960T1	SOT-223	1000 Tape & Reel
MMFT960T1G	SOT-223 (Pb-Free)	1000 Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

Preferred devices are recommended choices for future use and best overall value.

MMFT960T1

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Cha	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage (V _{GS} = 0, I _D = 10 μA)	,	V _{(BR)DSS}	60	-	_	Vdc
Zero Gate Voltage Drain Current (V _{DS} = 60 V, V _{GS} = 0)		I _{DSS}	_	-	10	μAdc
Gate-Body Leakage Current (V _{GS} = 15 Vdc, V _{DS} = 0)		I _{GSS}	_	-	50	nAdc
ON CHARACTERISTICS (Note 2)						
Gate Threshold Voltage (V _{DS} = V _{GS} , I _D = 1.0 mAdc)		V _{GS(th)}	1.0	_	3.5	Vdc
Static Drain-to-Source On-Resistar (V _{GS} = 10 Vdc, I _D = 1.0 A)	R _{DS(on)}	_	-	1.7	Ω	
Drain-to-Source On-Voltage $(V_{GS} = 10 \text{ V}, I_D = 0.5 \text{ A})$ $(V_{GS} = 10 \text{ V}, I_D = 1.0 \text{ A})$		V _{DS(on)}	_ _	_ _	0.8 1.7	Vdc
Forward Transconductance (V _{DS} = 25 V, I _D = 0.5 A)			_	600	_	mmhos
DYNAMIC CHARACTERISTICS						
Input Capacitance		C _{iss}	-	65	-	pF
Output Capacitance $(V_{DS} = 25 \text{ V}, V_{GS} = 0, f = 1.0 \text{ MHz})$ Transfer Capacitance		C _{oss}	_	33	-	
		C _{rss}	-	7.0	-	
Total Gate Charge		Q_{g}	_	3.2	-	nC
Gate–Source Charge $(V_{GS} = 10 \text{ V}, I_D = 1.0 \text{ A}, V_{DS} = 48 \text{ V})$		Q _{gs}	_	1.2	-	
Gate-Drain Charge	Gate-Drain Charge			2.0	-	1

^{2.} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2.0%.

TYPICAL ELECTRICAL CHARACTERISTICS

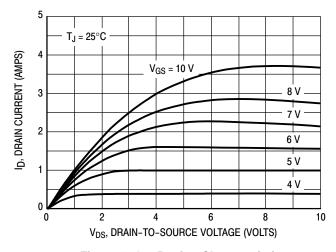


Figure 1. On-Region Characteristics

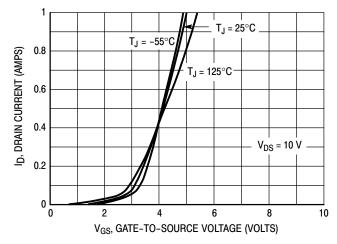
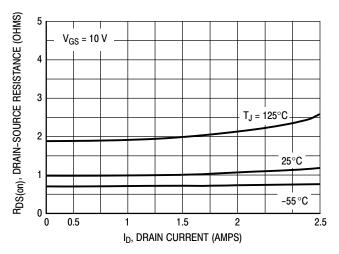


Figure 2. Transfer Characteristics

MMFT960T1

TYPICAL ELECTRICAL CHARACTERISTICS



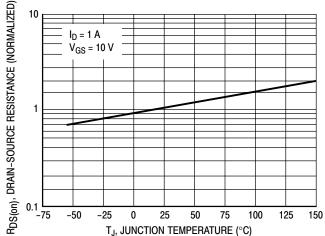
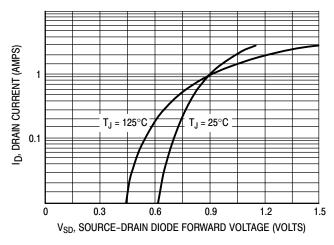


Figure 3. On-Resistance versus Drain Current

Figure 4. On-Resistance Variation with Temperature



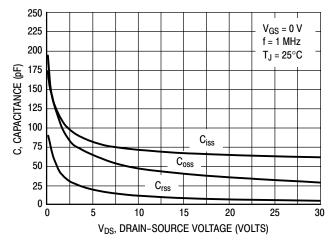
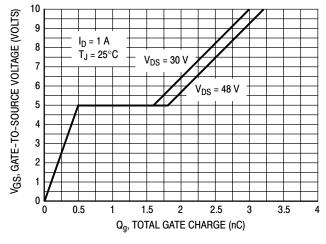


Figure 5. Source-Drain Diode Forward Voltage

Figure 6. Capacitance Variation



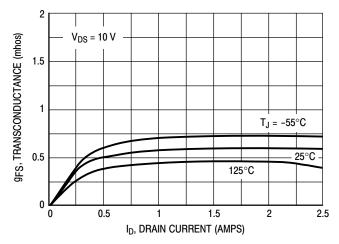


Figure 7. Gate Charge versus Gate-to-Source Voltage

Figure 8. Transconductance



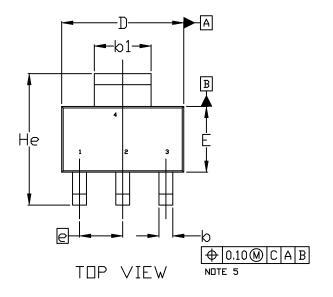
MECHANICAL CASE OUTLINE

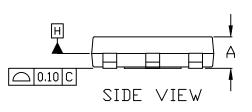
PACKAGE DIMENSIONS

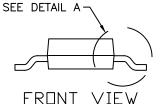


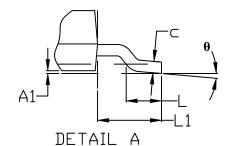
SOT-223 (TO-261) CASE 318E-04 ISSUE R

DATE 02 OCT 2018





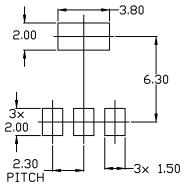




NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- CONTROLLING DIMENSION: MILLIMETERS
- DIMENSIONS D & E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH, PROTRUSIONS OR GATE BURRS SHALL NOT EXCEED 0.200MM PER SIDE.
- 4. DATUMS A AND B ARE DETERMINED AT DATUM H.
- A1 IS DEFINED AS THE VERTICAL DISTANCE FROM THE SEATING PLANE TO THE LOWEST POINT OF THE PACKAGE BODY.
- POSITIONAL TOLERANCE APPLIES TO DIMENSIONS b AND b1.

	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α	1.50	1.63	1.75	
A1	0.02	0.06	0.10	
b	0.60	0.75	0.89	
b1	2.90	3.06	3.20	
c	0.24	0.29	0.35	
D	6.30	6.50	6.70	
E	3.30	3.50	3.70	
е		2.30 BSC	;	
L	0.20			
L1	1.50	1.75	2.00	
He	6.70	7.00	7.30	
θ	0*	10°		



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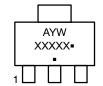
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DATE 02 OCT 2018

STYLE 1: PIN 1. BASE 2. COLLECTOR 3. EMITTER 4. COLLECTOR	STYLE 2: PIN 1. ANODE 2. CATHODE 3. NC 4. CATHODE	STYLE 3: PIN 1. GATE 2. DRAIN 3. SOURCE 4. DRAIN	STYLE 4: PIN 1. SOURCE 2. DRAIN 3. GATE 4. DRAIN	STYLE 5: PIN 1. DRAIN 2. GATE 3. SOURCE 4. GATE
STYLE 6: PIN 1. RETURN 2. INPUT 3. OUTPUT 4. INPUT	STYLE 7: PIN 1. ANODE 1 2. CATHODE 3. ANODE 2 4. CATHODE	STYLE 8: CANCELLED	STYLE 9: PIN 1. INPUT 2. GROUND 3. LOGIC 4. GROUND	STYLE 10: PIN 1. CATHODE 2. ANODE 3. GATE 4. ANODE
STYLE 11: PIN 1. MT 1 2. MT 2 3. GATE 4. MT 2	STYLE 12: PIN 1. INPUT 2. OUTPUT 3. NC 4. OUTPUT	STYLE 13: PIN 1. GATE 2. COLLECTOR 3. EMITTER 4. COLLECTOR		

GENERIC MARKING DIAGRAM*



A = Assembly Location

Y = Year

W = Work Week
XXXXX = Specific Device Code

= Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

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